BTS6303U



Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz Rev. 5 — 18 October 2022

Product data sheet

General description

The BTS6303U is a wideband, high linearity, pre-driver amplifier for 5G massive MIMO infrastructure applications, with fast on-off switching to support TDD systems. The amplifier is designed to operate between 2.3 GHz and 4.2 GHz. It is housed in a 3 mm x 3 mm x 0.85 mm 16-terminal HVQFN package. The amplifier is ESD protected on all terminals.

Features and benefits 2

- High saturated output power P_{o(sat)} = 28 dBm, at 3.5 GHz
- High power gain G_p = 37 dB
- High linearity performance ACLR = -40 dBc
- Programmable bias current (via external resistor)
- · Fast switching to support TDD systems
- 5 V single supply, quiescent current 67 mA
- Small 16-terminal leadless package 3 mm x 3 mm x 0.85 mm
- · ESD protection on all terminals
- · Moisture sensitivity level 1

Applications

- · Wireless infrastructure 5G NR mMIMO
- · High linearity pre-driver
- TDD systems



Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

4 Quick reference data

Table 1. Quick reference data

Unless otherwise specified, the following settings are used for measurements: f = 3.5 GHz; V_{CC} = 5 V; T_{amb} = 25 °C; input and output 50 Ω ; R_{SET} = 10 k Ω .

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
I _{CC}	supply current	ON state, P _o = 15 dBm	-	94	116	mA
		ON state, quiescent	-	67	87	mA
		OFF state	-	1	-	mA
Gp	power gain	ON state, f = 3.5 GHz	35	37.9	41.2	dB
		OFF state	-	-50	-	dB
P _{o(sat)}	saturated output power	f = 3.5 GHz	-	28	-	dBm
ACLR	adjacent channel leakage ratio	CP-OFDM with 100 MHz channel BW, QPSK modulation, and 60 kHz SCS, fully allocated, P_0 = 15 dBm	-	-40	-	dBc

5 Ordering information

Table 2. Ordering information

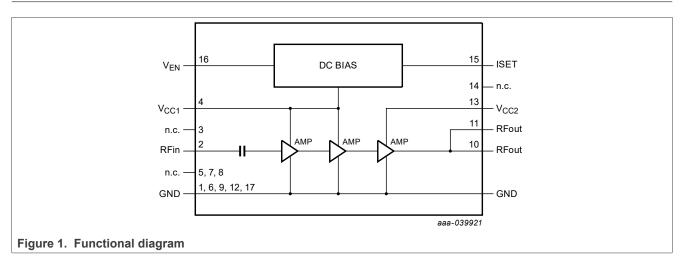
• •	Orderable part	Package		
	number	Name	Description	Version
BTS6303U	BTS6303UJ	HVQFN16	3 mm x 3 mm x 0.85 mm, 16 terminals no leads	SOT758-1

6 Marking

Table 3. Marking

Type number	Marking code
BTS6303U	33U

7 Functional diagram



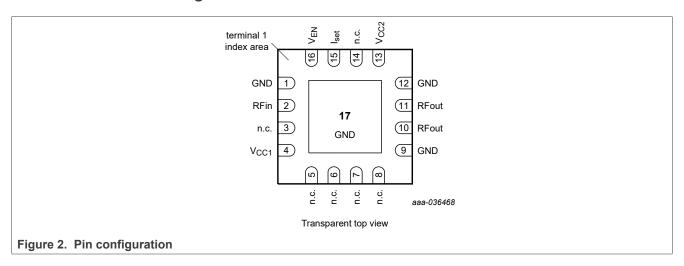
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Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

8 Pinning information

8.1 Pinning



8.2 Pin description

Table 4. Pin description

Pin	Symbol	Description
1, 9, 12 and 17	GND	PCB ground
2	RFin	RF input
3	n.c.	PCB ground, or connect to RFin
5, 6, 7, 8 and 14	n.c. [1]	PCB ground
10 and 11	RFout	RF output; connect both to the same track
4	V _{CC1}	supply voltage
13	V _{CC2}	supply voltage
15	I _{set}	current set; connect to external resistor
16	V _{EN}	voltage enable; LOW = OFF state; HIGH = ON state

^[1] n.c. means that pin is not connected inside package, and may be left floating in application

9 Functional description

Table 5. Shutdown control

V _{EN}	voltage applied at pin V _{EN} [1]	State	Condition
LOW	$0 < V (V_{en}) < V_{IL(max)}$	OFF	bias active, amplifier not active
HIGH	$V_{IH(min)} < V(V_{en}) < V_{I(max)}$	ON	bias active, amplifier active

^[1] V_{EN} can only be made HIGH, after supply voltage has been applied to pin V_{CC1}

BTS6303U

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Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

10 Limiting values

Table 6. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.3	6	V
V _{EN}	enable voltage		-0.3	4	V
V _{I(set)}	current set voltage		-0.3	4	V
P _{i(RF)CW}	continuous waveform RF input power	ON state, OFF state	-	10	dBm
T _{stg}	storage temperature		-50	150	°C
Tj	junction temperature		-	175	°C
MTTF	mean time to failure	at T _J = 165 °C	-	1.6E6	h
V _{ESD}	electrostatic discharge voltage	Human Body Model (HBM) According to ANSI/ESDA/JEDEC standard JS-001	-	+/-2	kV
		Charged Device Model (CDM); According to ANSI/ESDA/JEDEC standard JS-002	-	+/-500	V

11 Recommended operating conditions

Table 7. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage	[1]	4.75	5	5.25	V
V _{IL}	LOW-level input voltage		0	-	0.6	V
V _{IH}	HIGH-level input voltage		1.2	-	3.6	V
V _{I(max)}	maximum input voltage		-	-	3.6	V
Z ₀	characteristic impedance		-	50	-	Ω
T _{case}	case temperature		-40	-	115	°C

^[1] V_{CC} must be applied to pin V_{CC1} before, or at the same time as applying V_{CC} to pin V_{CC2}

12 Thermal characteristics

Table 8. Thermal characteristics

Symbol	Parameter	Conditions	Тур	Unit
R _{th(j-case)}	junction to case thermal resistance	[1] [2]	50	K/W

^[1] Case is ground solder pad.

BTS6303U

^[2] Thermal resistance determined with device mounted, and device bottom case kept at constant temperature.

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

13 Characteristics

Table 9. Characteristics

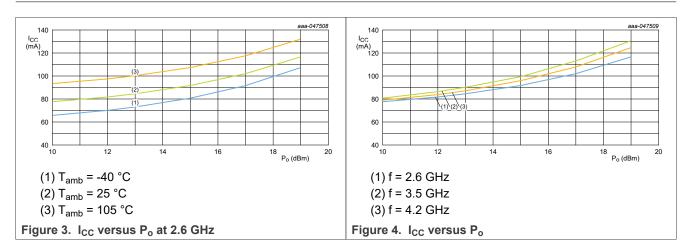
Unless otherwise specified, the following settings are used for measurements: f = 3.5 GHz; $V_{CC} = 5$ V; $T_{amb} = 25$ °C; input and output 50 Ω ; R_{SET} = 10 k Ω ; unless otherwise specified.

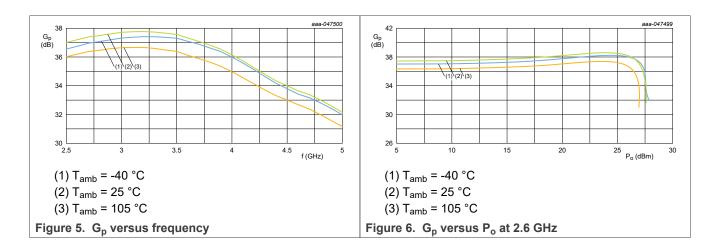
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I _{CC}	supply current	ON state, P _o = 15 dBm		-	94	116	mA
		ON state, quiescent		-	67	87	mA
		OFF state		-	1.1	-	mA
G _p	power gain	ON state					
		f = 2.6 GHz		34.3	36.3	39	dB
		f = 3.5 GHz		35	37.9	41.2	dB
		f = 4.2 GHz		32.2	34.6	39	dB
		OFF state		-	-50	-	dB
G _{flat}	gain flatness	f = 2.3 GHz to 2.7 GHz		-	0.9	-	dB
		f = 3.3 GHz to 3.8 GHz		-	0.9	-	dB
		f = 3.8 GHz to 4.2 GHz		-	1.6	-	dB
t _{d(grp)}	group delay time	f = 2.3 GHz to 2.7 GHz		-	0.3	-	ns
		f = 3.3 GHz to 3.8 GHz		-	0.3	-	ns
		f = 3.8 GHz to 4.2 GHz		-	0.3	-	ns
P _{o(sat)}	saturated output power	f = 2.6 GHz	[1]	-	27.5	-	dBm
		f = 3.5 GHz	[1]	-	28	-	dB
		f = 4.2 GHz	[1]	-	26.9	-	dB
P _{L(1dB)}	output power at1 dB	f = 2.6 GHz		-	27.2	-	dBm
	gain compression	f = 3.5 GHz		-	27.6	-	dBm
		f = 4.2 GHz		-	26.4	-	dBm
IP3 _o	output third-order intercept point	2-tone; tone spacing = 100 MHz; P _o = 15 dBm		-	29.2	-	dBm
RLi	input return loss			-	11.4	-	dB
RLo	output return loss			-	10	-	dB
ISL _r	reverse isolation			-	49	-	dB
NF	noise figure		[2]	-	3.4	-	dB
t _{s(pon)}	power-on settling time	V _{EN} from LOW to HIGH to output power reaching 90 % of final power		-	0.12	-	μs
t _{s(poff)}	power-off settling time	V _{EN} from HIGH to LOW to output power reaching 10 % below initial power		-	0.06	-	μs
K	Rollett stability factor	1 MHz to 5 GHz		1	-	-	
ACLR	adjacent channel leakage ratio	CP-OFDM with 100 MHz channel BW, QPSK modulation, and 60 kHz SCS, fully allocated, P _o = 15 dBm		-	-40	-	dBc

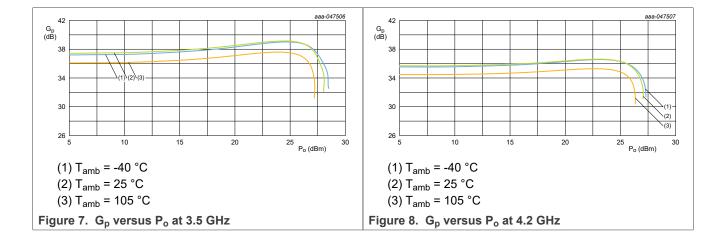
Connector and Printed-Circuit Board (PCB) losses have been de-embedded, 3 dB gain compression Connector and Printed-Circuit Board (PCB) losses have been de-embedded

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

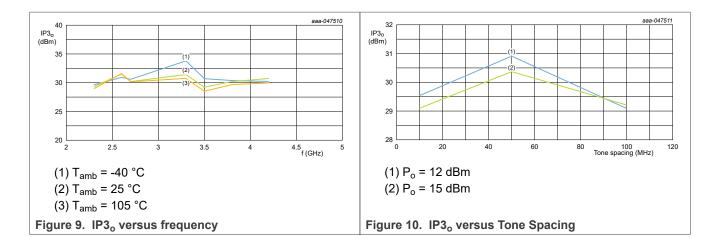
14 Graphs

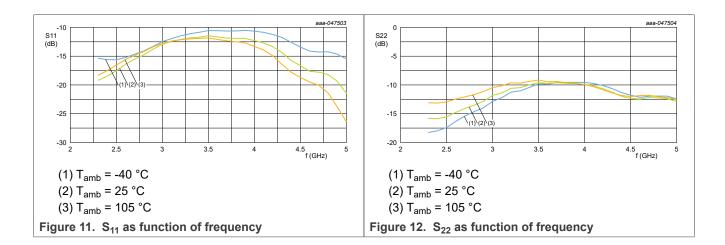


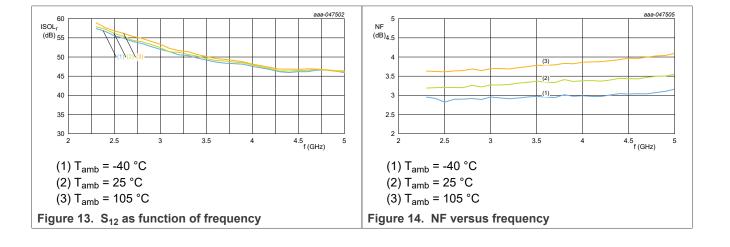




Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz







Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

15 Application information

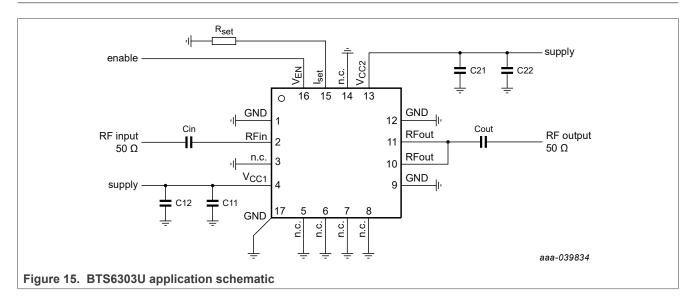


Table 10. List of components See <u>Figure 15</u> for schematics.

Component		Description	Value	Remarks
C _{in}		capacitor	3.3 pF	for DC blocking / matching
C _{out}		capacitor	18 pF	for DC blocking
C11, and C21		capacitor	10 nF	must be close (< 10 mm) to the IC
C12, and C22	[1]	capacitor	1 µF	must be close (< 10 mm) to the IC
RSET		resistor	10 ΚΩ	if lower resistor value is applied, a stability check is required

[1] Optional

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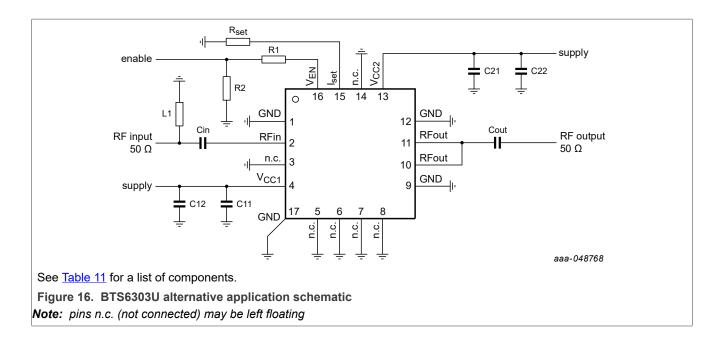


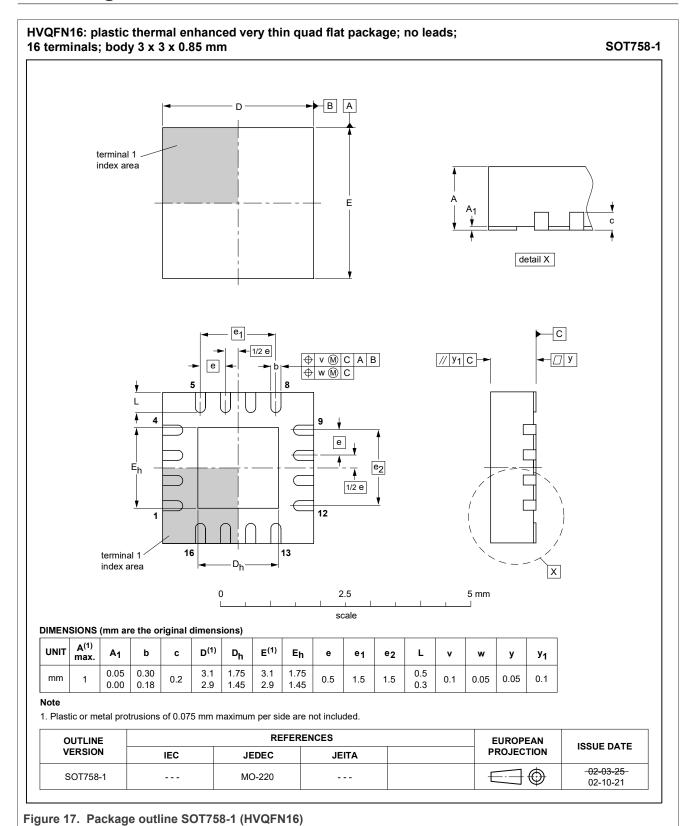
Table 11. List of components See <u>Figure 16</u> for schematics.

Component	Description	Value	Remarks
L1	inductor	3.3 nH	for optional matching / filtering
C _{in}	capacitor	3.3 pF	for DC blocking / matching
C _{out}	capacitor	18 pF	for DC blocking
C11, and C21	capacitor	10 nF	must be close (< 10 mm) to the IC
C12, and C22 [1]	capacitor	1 μF	must be close (< 10 mm) to the IC
RSET	resistor	10 ΚΩ	if lower resistor value is applied, a stability check is required
R1	resistor	5 ΚΩ	for EN pin protection
R2	resistor	100 ΚΩ	optional for EN pin protection

[1] Optional

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

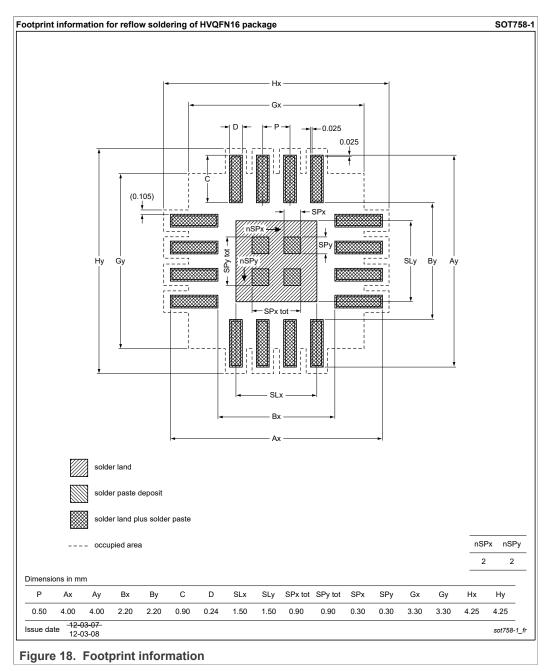
16 Package outline



BTS6303U

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

16.1 Footprint and solder information



17 Handling information

CAUTION



This device is sensitive to ElectroStatic Discharge (ESD). Observe precautions for handling electrostatic sensitive devices.

Such precautions are described in the ANSI/ESD S20.20, IEC/ST 61340-5, JESD625-A or equivalent standards.

BTS6303U

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Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

18 Abbreviations

Table 12. Abbreviations

Acronym	Description				
5G NR	5 th generation new radio				
ACLR	adjacent channel leakage ratio				
CP-OFDM	cyclic prefix orthogonal frequency division multiplexing				
ESD	electrostatic discharge				
mMIMO	massive multiple-input multiple-output				
PA	power amplifier				
RF	radio frequency				
TDD	time-division duplexing				

19 Revision history

Table 13. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes	
BTS6303U V.5	20221018	Product data sheet	-	BTS6303U V.4.1	
modification	 added graphs changed status to Product data sheet changed security status to public (no security status on the pdf) added MTTF to the Limiting values updated values for power gain added alternative application information 				
BTS6303U V.4.1	20220411	Preliminary data sheet	-	BTS6303U V.4	
modification	Corrected the revision number on the first page. The number was not in line with the revision history				
BTS6303U V.4	20220411	Preliminary data sheet	-	BTS6303U V.3	
modification	changed values on several parameters				
BTS6303U V.3	20211110	Preliminary data sheet	-	BTS6303U V.2	
modification	changed status to Preliminary data sheetchanged value on several parameters				
BTS6303U V.2	20210326	Objective data sheet	-	BTS6303U V.1.2	
modification	 changed Typical value on some characteristics changed ESD value on CDM from +/-1 KV to +/-500 V changed R_{SET} to 10 KΩ changed remarks on the capacitors in the List of components table changed condition on K factor in the Characteristics table 				
BTS6303U V.1.2	20201125	Objective data sheet	-	BTS6303U V.1.1	
modification	added official drawing of the Functional diagram				
BTS6303U V.1.1	20201120	Objective data sheet	-	BTS6303U V.1	

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

Table 13. Revision history...continued

Document ID	Release date		Change notice	Supersedes
modification	 changed values on some characteristics added condition 3.8 GHz to 4.2 GHz to G_{flat}, and t_{d(grp)} 			
BTS6303U V.1	20201118	Objective data sheet	-	-

Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

20 Legal information

20.1 Data sheet status

Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
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Wideband high linearity pre-driver amplifier 2.3 GHz - 4.2 GHz

Contents

1	General description	1
2	Features and benefits	1
3	Applications	1
4	Quick reference data	2
5	Ordering information	2
6	Marking	
7	Functional diagram	2
8	Pinning information	
8.1	Pinning	
8.2	Pin description	3
9	Functional description	3
10	Limiting values	
11	Recommended operating conditions	
12	Thermal characteristics	
13	Characteristics	5
14	Graphs	6
15	Application information	8
16	Package outline	
16.1	Footprint and solder information	11
17	Handling information	11
18	Abbreviations	
19	Revision history	
20	Legal information	

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